

# **MOSFET**

## OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V

#### **Features**

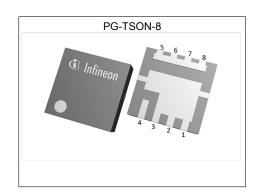
- Optimized for high performance SMPS, e.g. synchronous rectification
- N-channel, logic level
  Very low on-resistance R<sub>DS(on)</sub>
  Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

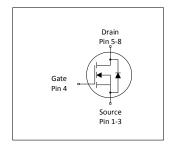
#### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

Table 1 Rey 1 differmation 1 arameters							
Parameter	Value	Unit					
V <sub>DS</sub>	60	V					
R <sub>DS(on),max</sub> @10V	2.2	mΩ					
R <sub>DS(on),max</sub> @4.5V	2.9	mΩ					
I <sub>D</sub>	151	A					
Qoss	45	nC					
Q <sub>G</sub> (0V4.5V)	26	nC					











Type / Ordering Code	Package	Marking	Related Links
IQE022N06LM5	PG-TSON-8	022N6L5	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V



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# OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V IQE022N06LM5



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Damanastan	0		Value	S		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	$I_{D}$	- - -	- - -	151 107 93 24	A	V <sub>GS</sub> =10 V, T <sub>C</sub> =25 °C V <sub>GS</sub> =10 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =4.5 V, T <sub>C</sub> =100 °C V <sub>GS</sub> =10 V, T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 °C/W <sup>2</sup> )
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	604	Α	<i>T</i> <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	241	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	100 2.5	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 °C/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	-

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Darameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	0.9	1.5	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	60	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V IQE022N06LM5



### 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

D	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	1.1	1.7	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=48\ \mu{\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1.0 100	μΑ	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	1.9 2.5	2.2 2.9	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A V <sub>GS</sub> =4.5 V, I <sub>D</sub> =10 A
Gate resistance	R <sub>G</sub>	-	1.1	1.4	Ω	-
Transconductance <sup>1)</sup>	<b>g</b> fs	-	93	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Paramatan	Oursels al	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	3400	4420	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	720	936	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	35	63	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	6.1	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	4.1	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	26	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	5.9	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Danamatan	Oh al	Values			11	Nata (Tant Oan dition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	$Q_{gs}$	-	8.5	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	5.9	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge <sup>1)</sup>	$Q_{gd}$	_	8	12	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	$Q_{sw}$	-	10.7	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	26	33	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Qg	-	53	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Output charge <sup>1)</sup>	Qoss	_	45	59	nC	V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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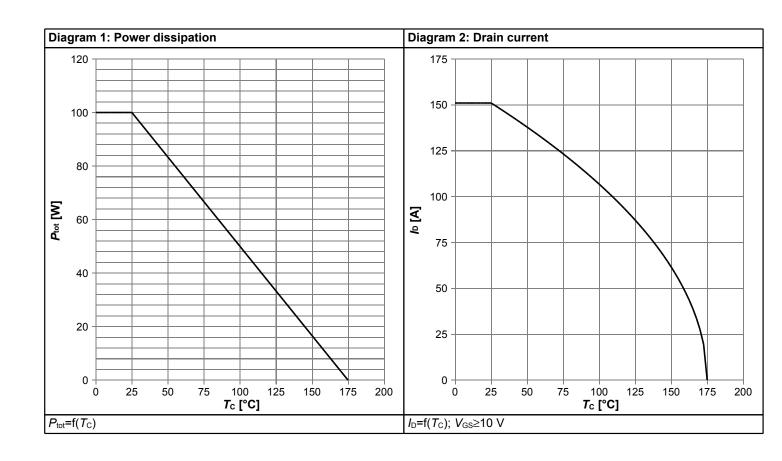


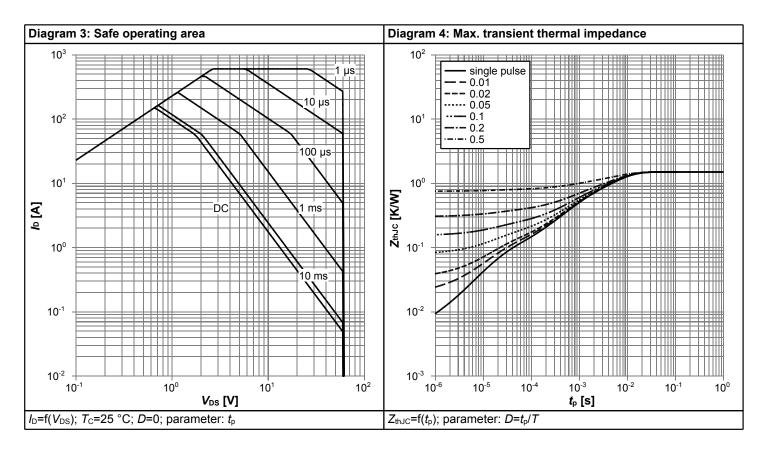
### Table 7 Reverse diode

Dougnatou	Cymahal		Values			Note (Tool Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	91	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	604	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.79	1.0	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	<i>t</i> <sub>rr</sub>	-	26	52	ns	V <sub>R</sub> =30 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	19	38	nC	V <sub>R</sub> =30 V, I <sub>F</sub> =20 A, di <sub>F</sub> /dt=100 A/μs	
Reverse recovery time <sup>1)</sup>	<i>t</i> <sub>rr</sub>	-	17	34	ns	V <sub>R</sub> =30 V, I <sub>F</sub> =20 A, di <sub>F</sub> /dt=1000 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	98	196	nC	$V_R$ =30 V, $I_F$ =20 A, $di_F/dt$ =1000 A/ $\mu$ s	

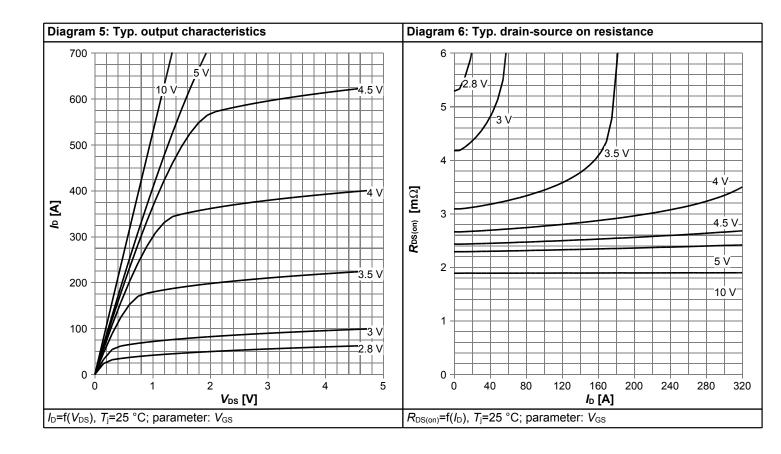


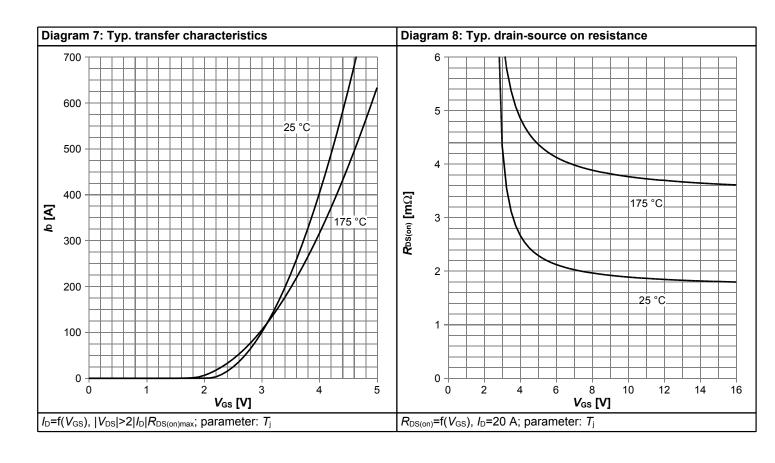
# 4 Electrical characteristics diagrams



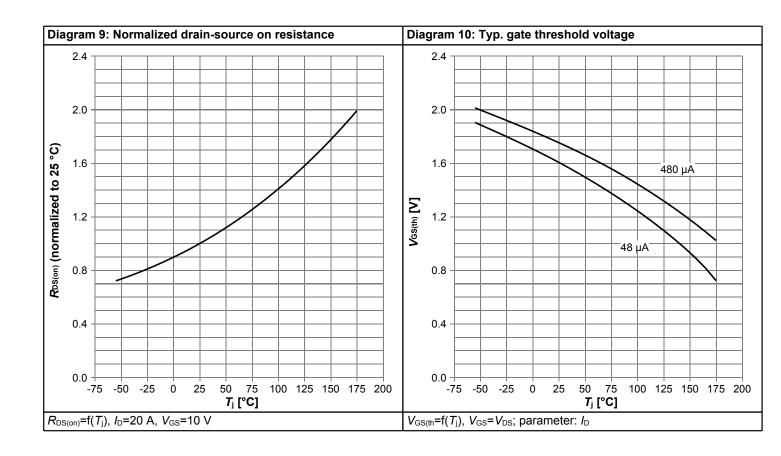


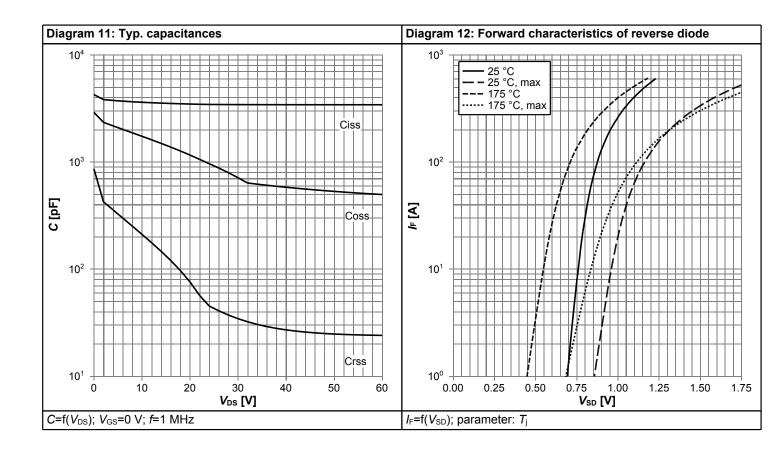




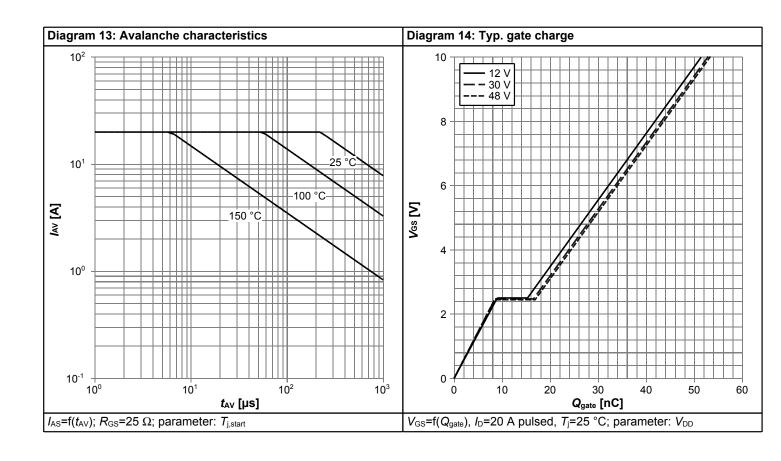


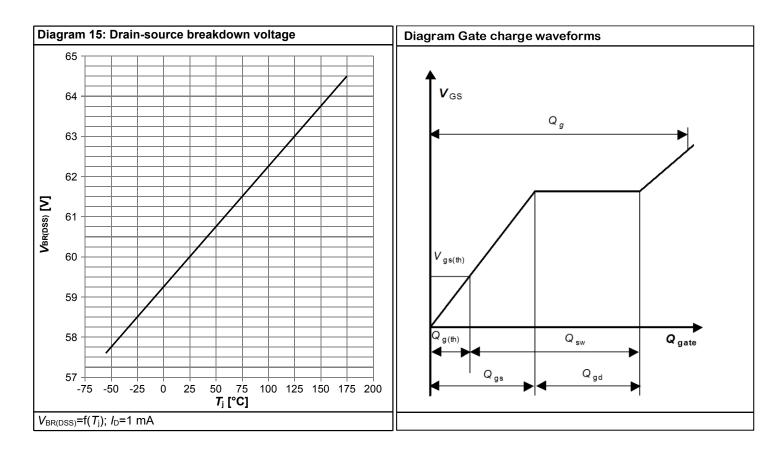






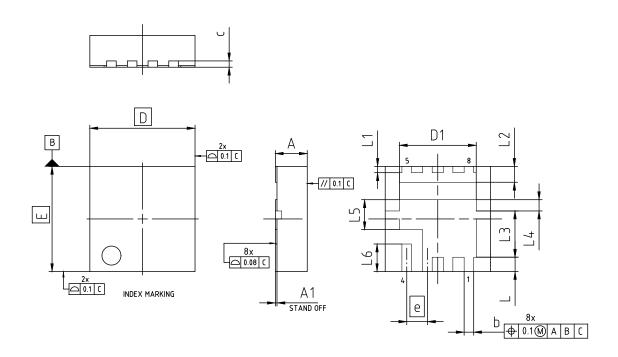








# 5 Package Outlines



DIMENSION	MILLIM	ETERS			
DIMENSION	MIN.	MAX.			
Α	-	1.10			
A1	-	0.05			
b	0.20	0.40			
С	0.	20			
D	3.	30			
D1	2.31	2.51			
E	3.	30			
е	0.65				
L	0.35	0.55			
L1	0.10	0.30			
L2	0.40	0.60			
L3	1.35	1.55			
L4	0.26	0.46			
L5	0.84 1.04				
L6	0.77	0.97			

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Figure 1 Outline PG-TSON-8, dimensions in mm

# OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V IQE022N06LM5



#### **Revision History**

IQE022N06LM5

Revision: 2023-01-12, Rev. 2.0

Previous Revision

Tevious revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2023-01-12	Release of final version				

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